506914170 10/09/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TSE-YAO HUANG	09/09/2021

RECEIVING PARTY DATA

Name:	NANYA TECHNOLOGY CORPORATION	
Street Address:	NO.98, NANLIN RD., TAISHAN DIST.	
City:	NEW TAIPEI CITY	
State/Country:	TAIWAN	
Postal Code:	243	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17497775

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER: USP-NT012

NAME OF SUBMITTER: XUAN ZHANG

SIGNATURE: /XUAN ZHANG/

DATE SIGNED: 10/09/2021

Total Attachments: 1

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PATENT 506914170 REEL: 057745 FRAME: 0591

US ONLY

ASSIGNMENT

WHEREAS, I(we), <u>HUANG, TSE-YAO</u>, whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

METHOD FOR FABRICATING SEMICONDUCTOR DEVICE WITH PLUG STRUCTURE

	INVENTION) for which an application for with unless at least one of the following is		ters Patent /Utility Patent
☐ United States Design	Patent was		
☐ executed on:			
☐ filed on:	Serial No.:		
established by PCT It	nternational Patent Application No.:	filed:	designating the
United States of America			
☐ issued on	as U.S. Patent No.:		
TAISHAN DIST., NEW TAI	NOLOGY CORPORATION, whose p PEI CITY 243, TAIWAN (R.O.C.), here and interest in and to the same in the Un	einafter referred to	as Assignee, is desirous of

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof, and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

·Assignor Name HUANG, TSE-YAO	Address 12F., NO. 142, SEC. 2, NANGANG RD., NANGANG DIST., TAIPEI CITY 115, TAIWAN (R.O.C.)
Signature of Assignor HUANG, JAR YOU	Date of Signature (X) ZOZI /9/9
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

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RECORDED: 10/09/2021